

JUN 22 2004

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Yoshino
Serial No: 09/909,013
Filed: 7/19/2001
For: SEMICONDUCTOR PACKAGE INSULATION FILM AND
MANUFACTURING METHOD THEREOF

Docket No: TI-29448
Examiner: Geyer, Scott
Art Unit: 2829

OFFICIAL

AMENDMENT UNDER 37 C.F.R. § 1.115

Assistant Commissioner For Patents
Washington, DC 20231

CERTIFICATION OF FACSIMILE TRANSMISSION

I hereby certify that the following papers are being
transmitted by facsimile to the U.S. Patent and Trademark
Office at 703-872-9306 on 6-22-04:

Tommie Chambers
Tommie Chambers

Dear Sir:

Responsive to the Office Action mailed February 27, 2004 in connection with the
above identified application, Applicants respectfully submit the following amendments
and remarks.